

Nuvo-8108GC-QD

Industrial-grade Edge AI Platform Supporting NVIDIA® RTX A6000/ A4500 GPU, Intel® Xeon® E and 9th/ 8th-Gen Core™



Key Features

- · Supports NVIDIA® RTX A6000/ A4500 GPU cards
- · Supports Intel® Xeon® E or 9th/ 8th-Gen Core™ i7/ i5 LGA1151 CPU
- · Up to 128GB ECC/ non-ECC DDR4 2133 (4x SODIMM)
- · One x16 (8-lanes), one x8 (4-lanes), Gen3 PCIe slots for add-on cards
- · Dedicated GPU card bracket
- · 8~48V wide-range DC input with built-in ignition power control
- · Patented thermal design for -25°C to 60°C rugged operation*
- · Patented damping brackets* to withstand 3 Grms vibration

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*R.O.C Patent No. M534371 / M491752

Introduction

Nuvo-8108GC-QD, the latest member of the well-received Nuvo-8108GC series, is a rugged edge Al platform specially designed for NVIDIA® RTX A6000 and RTX A4500 Ampere GPU cards. The GPUs offer tremendous computing power and product longevity, to take GPU-accelerated edge Al applications such as autonomous driving, vision inspection and intelligent video analytics to the next level of reliability and availability.

Powered by an Intel® Xeon® E or 9th/ 8th-Gen Core™ (up to 8-core/ 16-thread) CPU with workstation-grade Intel® C246 chipset to support up to 128 GB ECC or non-ECC DDR4 memory, it has a strong foundation for building a powerful AI edge computing platform. It has a refined thermal dissipation design to optimize GPU performance in high-temperature environments. Additionally, Nuvo-8108GC-QD comes with a dedicated mounting bracket for RTX A6000/ A4500 to keep the GPU card firmly secured in the PCIe slot. Along with Neousys' patented damping brackets*, it ensures rock-solid operation in intensive shock and vibration conditions.

The addition of RTX A6000/ A4500 to Neousys' GPU computer portfolio realizes an edge AI platform with system-level longevity and up to 28 TFLOPS computing power. Combining proven power design, guaranteed thermal performance, and superior mechanical ruggedness, Nuvo-8108GC-QD brings unprecedented longevity, computing power, flexibility and reliability to edge AI computing.

Specifications

System Core	
Processor	Supporting Intel® Xeon® E and 9th/ 8th-Gen CPU (LGA1151 socket) - Xeon E 2176G/ 2278GE (8C/16T) / 2278GEL (8C/16T) - i7-9700E, i7-9700TE, i7-8700, i7-8700T - i5-9500E, i5-9500TE, i5-8500T - i3-9100E, i3-9100TE, i3-8100, i3-8100T
Chipset	Intel® C246 Platform Controller Hub
Graphics	Independent NVIDIA® RTX A6000/ A4500 GPU via x16 PEG port, or integrated Intel® UHD graphics 630
Memory	Up to 128 GB ECC/ non-ECC DDR4 2133 SDRAM (four SODIMM slots)
AMT	Supports AMT 12.0
TPM	Supports TPM 2.0
I/O Interface	
Ethernet	1x Gigabit Ethernet port by Intel® I219-LM 1x Gigabit Ethernet port by Intel® I210-IT
Video Port	1x VGA , supporting 1920 x 1200 resolution 1x DVI-D, supporting 1920 x 1200 resolution 1x DisplayPort, supporting 4096 x 2304 resolution
Serial Port	2x software-programmable RS-232/ 422/ 485 ports (COM1/ COM2)
USB 3.1	4x USB 3.1 Gen2 (10 Gbps) ports 4x USB 3.1 Gen1 (5 Gbps) ports
USB 2.0	1x USB 2.0 ports (internal for dongle use)
Audio	1x 3.5 mm jack for mic-in and speaker-out
Storage Interface	•
SATA	1x hot-swappable HDD tray for 2.5" HDD/ SSD installation 1x Internal SATA port for 2.5" HDD/ SSD installation, supporting RAID 0/ 1
M.2	1x M.2 2280 M key socket (PCIe Gen3 x4) for NVMe SSD or Intel® Optane™ memory installation
mSATA	2x full-size mSATA port (mux with mini-PCle)

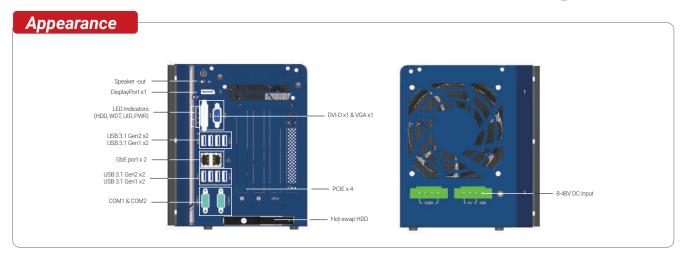
Expansion Bus	
PCI Express	2x PCle x16 slot@Gen3, 8-lanes 2x PCle x8 slots@Gen3, 4-lanes
M.2	1x M.2 2242 B key socket supporting dual SIM mode with selected M.2 LTE module
Mini-PCle	2x full-size mini PCI Express socket
Power Supply	
DC Input	2x 4-pin pluggable terminal block for 8 to 48V DC input with ignition control $^{\rm [t]}$
Mechanical	
Dimension	170.2 mm (W) x 360 mm (D) x 201.8 mm (H)
Weight	5.8 kg
Mounting	Neousys' patented damping brackets
Environmental	
Operating Temperature	with 35W CPU and one NVIDIA® RTX A6000/ A4500 GPU -25°C ~ 60°C ^{IBI} with >= 65W CPU and one NVIDIA® RTX A6000/ A4500 GPU -25°C ~ 60°C ^{IZ/IBI} (configured as 35W TDP mode) -25°C ~ 50°C ^{IZ/IBI} (configured as 65W TDP mode)
Storage Temperature	-40°C ~ 85°C
Humidity	10%~90%, non-condensing
Vibration	Operating, MIL-STD-810G, Method 514.6, Category 4
Shock	Operating, MIL-STD-810G, Method 516.6, Procedure I, Table 516.6-II
EMC	CE/ FCC Class A, according to EN 55024 & EN 55032

System load between 100W to 480W (single GPU), the required DC input range is 18V to 48V

[2] For 17-9700/ 8700 running at 65W mode, the highest operating temperature shall be limited to 50°C and thermal throttling may occur when sustained full-loading is applied. Users can configure CPU power in the BIOS to obtain higher operating temperatures.

[3] For sub-zero operating temperature, a wide temperature HDD or Solid State Disk (SSD) is required.

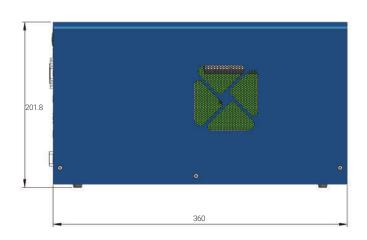




Dimensions

Unit:mm





Ordering Information

Model No.	Product Description
	Industrial-grade edge AI platform supporting NVIDIA® RTX A6000/ A4500 GPU, Intel® Xeon® E and 9th/ 8th-Gen Core™ processor with 8~48V wide-range DC input and built-in ignition control

Optional Accessories

PA-480W-DIN	480W AC-DC power Adapter(SDR-480-24) DIN-rail mount, 24V 20A, 90~264VAC/127~370VDC, Terminal Block, -20~+70°C, Meanwell SDR-480-24	
PA-600W-ENC	600W AC/DC power adapter 24V/25A; cord end terminals for terminal block, operating temperature: -20°C to 70°C.	